FR05DxDR

RedLink[®] Fiber Optic Receiver for up to 20 V Voltage Switching

Datasheet



DESCRIPTION

Firecomms FR05DxDR RedLink[®] receiver is based on a fully integrated photodiode with TIA, limiting amplifier and a MOSFET open drain output to handle switching of voltages in the range from 3 to 20 V (e.g. 3.3, 5, 12, 15 V). The part also includes an optional $1 \text{ k}\Omega$ pull-up resistor RL.

Housed in non-conducting plastic the RedLink[®] receiver connector is blue. The housings are compatible with the Versatile Link style of fiber plug and are optimised for use with Plastic Optic Fiber (POF).

The receiver operates over the industrial temperature range of -40 °C to +85 °C supporting many industrial applications where reliable command and control response is required in electrically harsh environments.

The receiver is typically used at low switching speeds where 12 V and 15 V power electronic devices are being switched at kHz speeds





FEATURES

- MOSFET output stage typically used to switch 12 V and 15 V thyristor gate devices
- Optimised for data rates from DC to 5 MBd
- Industrial temperature range -40 °C to +85 °C
- Flame retardant (UL 94 V-0) connector housings
- Fully integrated photodiode, TIA and limiting amplifier in a single IC
- Integrated 1 kΩ pull-up resistor to V_{CC} (R_L)
- Low pulse width distortion
- Horizontal, Vertical and 30° Tilted options
- Compatible with Versatile Link cables and connectors

AVAILABLE OPTIONS

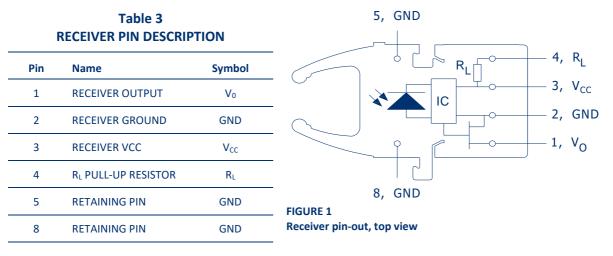
Table 1 ORDERING INFORMATION / PART NUMBERS				
5 MBd Horizontal Package Inverting, Open Drain	FR05DHDR			
5 MBd Vertical Package Inverting, Open Drain	FR05DVDR			
5 MBd Tilted Package Inverting, Open Drain	FR05DWDR			

APPLICATIONS

	Table 2 APPLICATIONS
Application	Switching of 20 V, 18 V, 15 V and 12 V thyristor gate drivers. SCR and IGBT switching
Distance	50 meters Step Index (SI) POF in typical operating conditions 30 meters in worst case conditions
Speed	DC to 5 MBd (depending on series resistance and load capacitance)



SPECIFICATIONS



GENERAL OPERATION

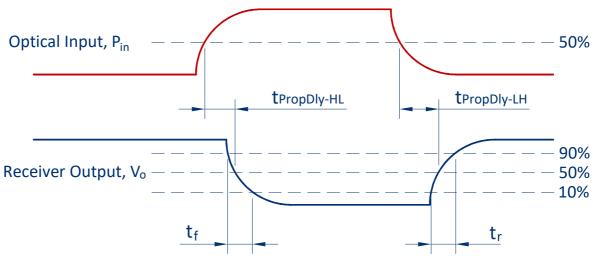


FIGURE 2 Receiver propagation delay and rise/fall time definitions



RECOMMENDED APPLICATION CIRCUITS

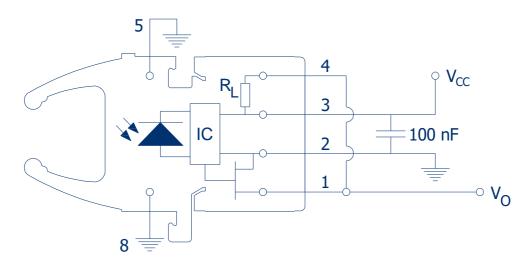


FIGURE 3

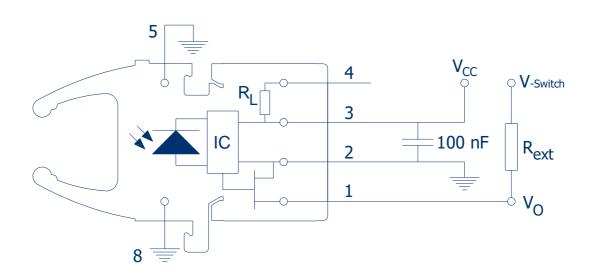


FIGURE 4

RedLink[®] Receiver interface circuit for High Voltage (up to 20 V) switching. V_{CC} can be 5 or 3.3 V. V_{-Switch} is often used to switch for example 12 V and 15 V thyristor gates devices

NOTE: if $V_{\text{-switch}} > V_{CC}$ then R_L should not be connected to V_0



SPECIFICATIONS

Table 4 REGULATORY COMPLIANCE

Parameter	Symbol	Standard	Level
Electrostatic Discharge, Human Body Model (contact ESD)	HBM	Mil-STD-883	Level 2 (2 kV)
UL Certification	UL	60950-1	Files No. E362227
Storage Compliance	MSL	J-STD-020	2a (4-week floor life)
Restriction of Hazardous Substances Directive	RoHS	Directive 2011/65/EU Incl. Amendment 2015/863	Certified compliant

Table 5 ABSOLUTE MAXIMUM RATINGS

These are the absolute maximum ratings at or beyond which the FOT can be expected to be damaged. These ratings are stress ratings only.

Notes:

1. 260 °C for 10 seconds, one time only, at least 2.2 mm away from lead root

2. Applying conditions above absolute maximum ratings is destructive to the device. Functional operation of the device at conditions between maximum operating conditions (5.5 V) and absolute maximum ratings is not implied. Extended exposure to stresses above recommended operating conditions will have an effect on device reliability

3. The R_L pin can only be used when the maximum value of V_0 does not exceed the maximum operating condition V_{cc} . The maximum operating condition V_{cc} is 5.5 V. For example, if V_0 switches between 0 and 5 V and V_{cc} is equal to 5 V then R_L can be connected to V_0 . However, if V_{cc} is 3.3 V and V_0 switches between 0 and 5 V then R_L cannot be connected to V_0 .

4. V_{switch} is the External Power Supply for the external Pull-Up resistor R_{ext}. The maximum allowed voltage that can be switched is 20 V.

Parameter	Symbol	Minimum	Maximum	Unit
Storage Temperature	T _{stg}	-40	+85	°C
Operating Temperature	T _{op}	-40	+85	°C
Soldering Temperature ^[1]	T _{sld}		+260	°C
Supply Voltage ^[2]	V _{cc}	-0.5	+7	V
Rx Output Current (maximum drain source current)	I _{FDC}		±25	mA
Storage Compliance	MSL		2a	J-STD-020
Maximum Output Power	P _{OD}		40	mW
R _L Pull-up Voltage ^[3]	V _{RL}	-0.5	Vcc	V
Output Voltage	Vo	-0.5	20	V
External V _{Switch} Power Supply ^[4]	V _{Switch}	-0.5	20	V



SPECIFICATIONS

Table 6 RECEIVER ELECTRICAL AND OPTICAL CHARACTERISTICS

Test Conditions:

- 1. Wake up Delay is the delay from when V_{cc} > 2.75 V to when the output will respond correctly to optical input.
- 2. Test data was validated using a transmitter with an emission wavelength between 635 and 680 nm with 5 ns rise and fall times, over the full temperature range of -40 °C to +85 °C, and over the full supply rail voltage options of 5 V and 3.3 V ± 10% and over the optical received power range P_H to P_L. Input power levels are for peak (not average) optical input levels. For 50% duty cycle data, peak optical power is twice the average optical power. Data referred to as typical are rated at ambient +25 °C.
- 3. Optical signal is delivered over 1 mm core, step index, 0.5 NA POF.
- 4. Measured in the interface circuit for high voltage, over the V_{cc} and V_{-switch} range 4.5 V to 5.5 V, ambient temperature range -40 °C to 85 °C, received optical power P_H = -1 to -20 dBm, at 5 Mbps. $R_{ext} = 560 \Omega$, $C_L = 22 pF$, $R_L pin o/c$.
- 5. R_L cannot be connected to Vo when Vo is used to switch a voltage greater than V_{cc} .
- 6. The performance of the receiver as given in Table 6 has been characterized for transmitters operating between 635 and 680 nm. The receiver will nevertheless respond to optical sources operating from the visible to near infra-red regions although the precise performance may differ from that given in Table 6 depending upon the precise wavelength and rise/fall time characteristics of the optical source used.

Parameter	Symbol	Min	Typical	Мах	Unit	Test Condition
Supply Current	I _{CC}	10.5	13	16	mA	[2,3,4]
Wake Up Delay	t _{power-on}		40		μs	[1,2,3,4]
High Level Output Current	I _{ОН}		0.5	100	μΑ	Vo=20 V, Received Power < P _L maximum
Low Level Output Voltage	V _{OL}		44	75	mV	Io = 25 mA, Received Power > P _H minimum
Optical Power High	P _H	-20		+2	dBm	[2,3]
Optical Power Low	PL			-40	dBm	[2,3]]
Data Rate		DC		5	MBd	Min-UI = 200 ns, Max f = 2.5 MHz
Output Rise Time (10% - 90%)	t _r	20	40	50	ns	[2,3,4]
Output Fall Time (90% - 10%)	t _f		3	10	ns	[2,3,4]
Pulse Width Distortion	PWD	-40		40	ns	[2,3,4]
Propagation Delay Low-to-High	t _{PropDly_LH}			80	ns	[2,3,4]
Propagation Delay High-to-Low	t _{PropDly_HL}			65	ns	[2,3,4]
Supply Voltage	V _{cc}	2.97		5.5	V	
External V _{switch} Power Supply	V_{Switch}	2.97		20	V	I _{0-max} = 25 mA
Output Current	Ι _Ο			25	mA	Maximum DC value
Internal Pull-Up Resistor to V _{CC}	R _L	0.7	1	1.5	kΩ	[5]
Optical Sensitivity Range	λ_{R}	400		900	nm	[6]



MECHANICAL DATA, HORIZONTAL

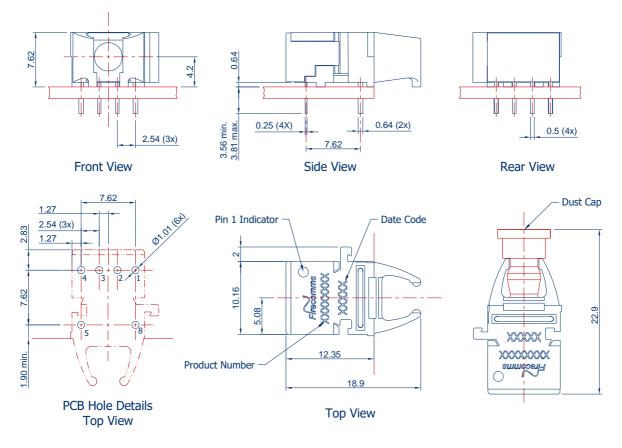


FIGURE 5

Mechanical dimensions of RedLink® horizontal connectors and PCB footprint, which is a top view General dimensional tolerance is \pm 0.2 mm

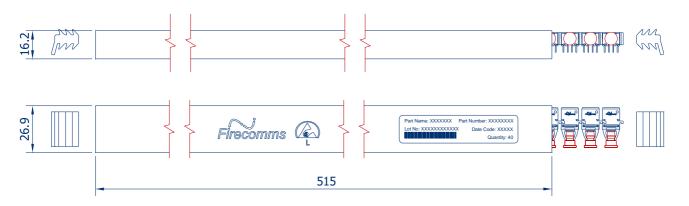


FIGURE 6 Packing tube for Firecomms RedLink[®] horizontal connectors



MECHANICAL DATA, VERTICAL

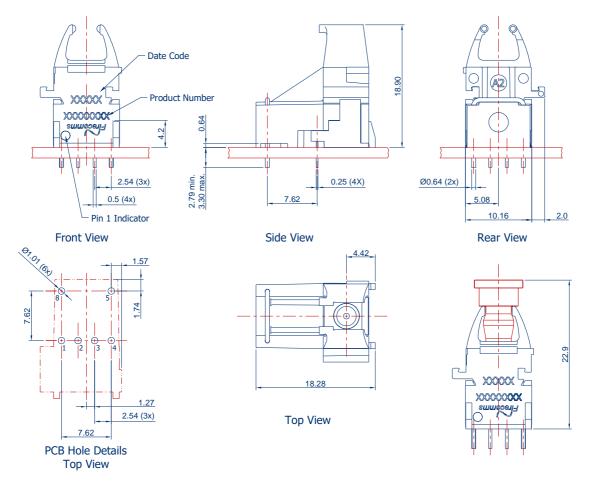


FIGURE 7

Mechanical dimensions of RedLink $^{\otimes}$ vertical connectors and PCB footprint, which is a top view General dimensional tolerance is \pm 0.2 mm

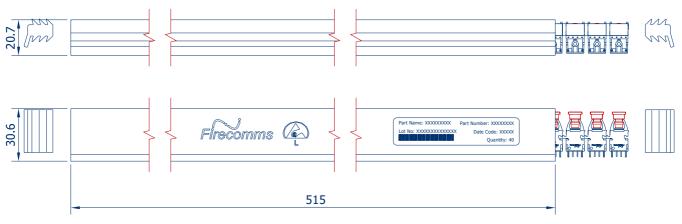


FIGURE 8 Packing tube for Firecomms RedLink® vertical connectors



MECHANICAL DATA, 30° TILTED

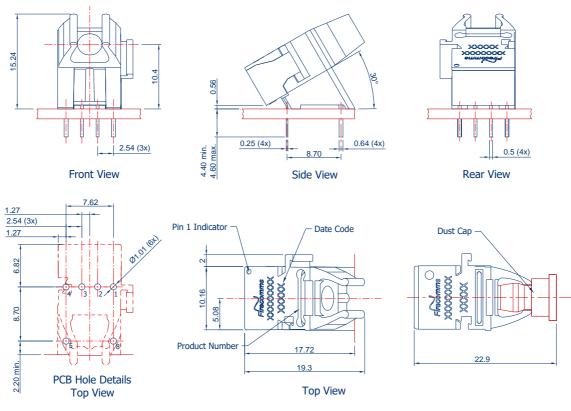


FIGURE 9

Mechanical dimensions of RedLink $^{\odot}\,$ tilted connectors and PCB footprint, which is a top view General dimensional tolerance is $\pm\,0.2$ mm

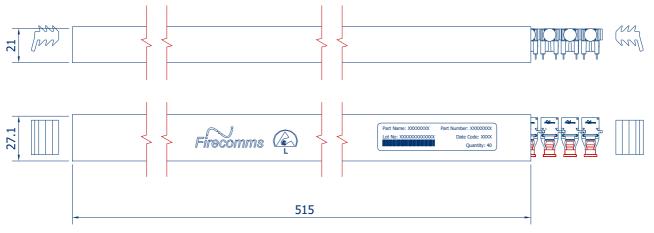


FIGURE 10 Packing tube for Firecomms RedLink® tilted connectors



PART HANDLING

Firecomms RedLink[®] connectors are auto-insertable and tested for handling in static-controlled assembly processes (Human Body Model - HBM). Cleaning, degreasing and post solder washing should be carried out using standard solutions compatible with both plastics and the environment. For example, recommended solutions for degreasing are alcohols (methyl, isopropyl and isobutyl). Acetone, ethyl acetate, phenol or similar solution-based products are not permitted.

In the soldering process, non-halogenated water-soluble fluxes are recommended. RedLink[®] connectors are not suitable for use in reflow solder processes (infrared/vapor-phase reflow). The dust plug should remain in place during soldering, washing and drying processes to avoid contamination of the active optical area of each part.

The Moisture Sensitivity Level (MSL) classification of this device is 2a according to JEDEC J-STD-020. The shelf life of an unopened MBB (Moisture Barrier Bag) is 24 months at < 40 °C and < 90 % R.H. Once the Moisture Barrier Bag is opened, the devices can be either;

- a) Stored in normal factory conditions < 30 °C and < 60 % R.H. for a maximum of 672 hours (4 Weeks) prior to soldering
- b) Stored at < 10 % R.H. (Dry Cabinet)



PACKING INFORMATION

Components are packed in PVC anti-static tubes and in moisture barrier bags. Bags should be opened only in staticcontrolled locations, and standard procedures should be followed for handling moisture sensitive components.

PACKING INFORMATION						
		Horizontal	Vertical	Tilted		
Components per Tube		40	40	40		
	Tube Length	515 mm	515 mm	515 mm		
	Tube Height	16.2 mm	20.7 mm	21 mm		
	Tube Depth	26.9 mm	30.6 mm	27.1 mm		
Tubes per Bag		5	5	5		
Bags per Inner Carton		1	1	1		
	Inner Carton Length	630 mm	630 mm	630 mm		
	Inner Carton Width	70 mm	70 mm	70 mm		
	Inner Carton Height	105 mm	105 mm	105 mm		
Weight per Inner Carton, Complete		0.77 kg	0.92 kg	0.92 kg		
Components per Inner Carton		200	200	200		
Inner Cartons per Outer Carton		10	10	10		
	Outer Carton Length	650 mm	650 mm	650 mm		
	Outer Carton Width	235 mm	235 mm	235 mm		
	Outer Carton Height	376 mm	376 mm	376 mm		
Weight per Outer Carton, Complete		8.13 kg	9.60 kg	9.60 kg		
Components per Outer Carton		2,000	2,000	2,000		

Table 7 PACKING INFORMATION

For the most recent revision or further information please visit <u>www.firecomms.com</u> or contact the company directly at the following address, Firecomms Ltd, 2200 Airport Business Park, Cork, IRELAND. Copyright© 2004-2022 Firecomms. All rights reserved. Firecomms refers to Firecomms Limited and/or its subsidiaries. Firecomms assumes no responsibility for inaccuracies or omissions in the information contained in this document. Specifications are subject to change without notice. No patent rights are granted to any of the circuits described herein.